

Discrete POWER & Signal **Technologies**

2N5769



NPN Switching Transistor

This device is designed for high speed saturated switching applications at currents to 100 mA. Sourced from Process 21. See PN2369A for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|-----------------------------------|---|-------|-------|
| V _{CEO} | Collector-Emitter Voltage | 15 | V |
| V _{CBO} | Collector-Base Voltage | 40 | V |
| V _{EBO} | Emitter-Base Voltage | 4.5 | V |
| I _C | Collector Current - Continuous | | mA |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range -55 to +150 °C | | °C |

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol | Characteristic | Max | Units |
|-----------------|--|------------|-------------|
| | | 2N5769 | |
| P _D | Total Device Dissipation Derate above 25°C | 350 2.8 | mW mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 125 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 357 | °C/W |



NPN Switching Transistor (continued)

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|----------------------|--------------------------------------|--|------|-----------|----------|
| | | | | | |
| | RACTERISTICS | _ | T | , | |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage* | $I_C = 10 \text{ mA}, I_B = 0$ | 15 | | V |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C = 10 \mu\text{A}, I_E = 0$ | 40 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 10 \mu A, I_C = 0$ | 4.5 | | V |
| V _{(BR)CES} | Collector-Emitter Breakdown Voltage | $I_{\rm C} = 10 \mu \text{A}, I_{\rm B} = 0$ | 40 | | V |
| I _{СВО} | Collector Cutoff Current | $V_{CB} = 20 \text{ V}, I_E = 0$ $V_{CB} = 20 \text{ V}, I_E = 0, T_A = 125 ^{\circ}\text{C}$ | | 0.4 30 | μΑ μΑ |
| I _{CES} | Collector Cutoff Current | $V_{CE} = 20 \text{ V}, I_{B} = 0$ | | 0.4 | μA |
| I _{EBO} | Emitter Cutoff Current | $V_{EB} = 4.5 \text{ V}, I_{C} = 0$ | | 1.0 | μΑ |
| η _{FE} | DC Current Gain | $I_C = 10 \text{ mA}, V_{CE} = 0.35 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 0.35 \text{ V}$ | 40 | 120 | |
| h _{FE} | DC Current Gain | | 40 | 120 | |
| | | $I_C = 10 \text{ mA}, V_{CE} = 0.35 \text{ V}$ $T_A = -55 ^{\circ}\text{C}$ | 20 | | |
| | | $I_C = 30 \text{ mA}, V_{CE} = 0.40 \text{ V}$ | 30 | | |
| | | $I_C = 100 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 20 | | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1.0 \text{ mA}$ | | 0.2 | V |
| | | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ $T_A = 125 ^{\circ}\text{C}$ | | 0.3 | V |
| | | $I_C = 30 \text{ mA}, I_B = 3.0 \text{ mA}$ | | 0.25 | V |
| | | $I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$ | | 0.5 | V |
| $V_{BE(sat)}$ | Base-Emitter Saturation Voltage | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ | 0.7 | 0.85 | V |
| | | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ $T_A = 125 ^{\circ}\text{C}$ | 0.59 | 1.02 | V |
| | | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ | 0.00 | 1.02 | ľ |
| | | T _A = - 55 °C | 0.59 | 1.02 | V |
| | | $I_C = 30 \text{ mA}, I_B = 3.0 \text{ mA}$ | | 1.15 | V V |
| | | $I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$ | | 1.6 | V |
| SMALL S | IGNAL CHARACTERISTICS | | | | |
| C _{cb} | Collector-Base Capacitance | $V_{CB} = 5.0 \text{ V}, f = 1.0 \text{ MHz}$ | | 4.0 | pF |
| h _{fe} | Small-Signal Current Gain | $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 100 MHz | 5.0 | | |
| SWITCHI | NG CHARACTERISTICS | | | | |
| t _{on} | Turn-on Time | $I_{C} = 10 \text{ mA},$ | | 12 | ns |
| t _{off} | Turn-off Time | $I_{B1} = 3.0 \text{ mA}, I_{B2} = 1.5 \text{ mA}$ | | 18 | ns |
| | | $I_C = I_{B1} = I_{B2} = 10 \text{ mA}$ | | 13 | |

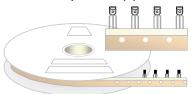
^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

TO-92 Tape and Reel Data FAIRCHILE SEMICONDUCTOR TM **TO-92 Packaging** Configuration: Figure 1.0 **TAPE and REEL OPTION** FSCINT Label sample See Fig 2.0 for various Reeling Styles **FSCINT** Label 5 Reels per Intermediate Box Customized F63TNR Label sample F63TNR LOT: CBVK741B019 QTY: 2000 FSID: PNZZZN Customized D/C1: D9842 QTY1: D/C2: QTY2: 375mm x 267mm x 375mm Intermediate Box TO-92 TNR/AMMO PACKING INFROMATION **AMMO PACK OPTION** See Fig 3.0 for 2 Ammo Packing Style Quantity EOL code Pack Options 2,000 D26Z 2.000 Ε D27Z М 2,000 D74Z 2.000 D75Z FSCINT $\begin{array}{ll} \mbox{Unit weight} & = 0.22 \mbox{ gm} \\ \mbox{Reel weight with components} & = 1.04 \mbox{ kg} \\ \mbox{Ammo weight with components} & = 1.02 \mbox{ kg} \\ \mbox{Max quantity per intermediate box} & = 10,000 \mbox{ units} \\ \end{array}$ Label 5 Ammo boxes per Intermediate Box 327mm x 158mm x 135mm Immediate Box Customized F63TNR Customized Label Label 333mm x 231mm x 183mm Intermediate Box (TO-92) BULK PACKING INFORMATION **BULK OPTION** See Bulk Packing LEADCLIP DIMENSION DESCRIPTION QUANTITY Information table TO-18 OPTION STD NO LEAD CLIP 2.0 K / BOX J18Z Anti-static TO-5 OPTION STD NO LEAD CLIP **Bubble Sheets** J05Z 1.5 K / BOX **FSCINT Label** NO EOI TO-92 STANDARD STRAIGHT FOR: PKG 92. NO LEADCLIP 2.0 K / BOX 94 (NON PROELECTRON SERIES), 96 TO-92 STANDARD STRAIGHT FOR: PKG 94 (PROELECTRON SERIES L34Z NO LEADCLIP 2.0 K / BOX 2000 units per 114mm x 102mm x 51mm BCXXX, BFXXX, BSRXXX), EO70 box for std option Immediate Box 5 EO70 boxes per intermediate Box 530mm x 130mm x 83mm Customized Intermediate box Label FSCINT Label 10,000 units maximum per intermediate box for std option

TO-92 Tape and Reel Data, continued

TO-92 Reeling Style Configuration: Figure 2.0

Machine Option "A" (H)



Style "A", D26Z, D70Z (s/h)

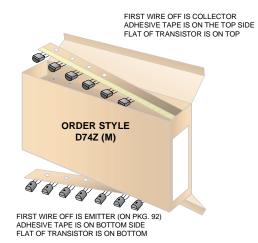
Machine Option "E" (J)

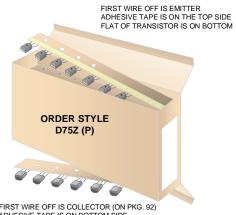


Style "E", D27Z, D71Z (s/h)

TO-92 Radial Ammo Packaging

Configuration: Figure 3.0

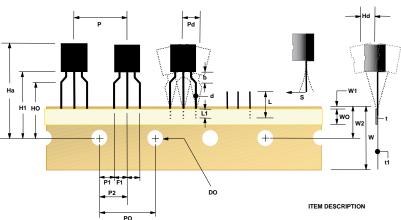




FIRST WIRE OFF IS COLLECTOR (ON PKG. 92) ADHESIVE TAPE IS ON BOTTOM SIDE FLAT OF TRANSISTOR IS ON TOP

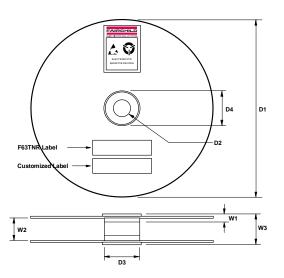
TO-92 Tape and Reel Data, continued

TO-92 Tape and Reel Taping Dimension Configuration: Figure 4.0



User Direction of Feed

TO-92 Reel Configuration: Figure 5.0



| ITEM DESCRIPTION | SYMBOL | DIMENSION |
|------------------------------------|--------|------------------------|
| Base of Package to Lead Bend | b | 0.098 (max) |
| Component Height | На | 0.928 (+/- 0.025) |
| Lead Clinch Height | НО | 0.630 (+/- 0.020) |
| Component Base Height | H1 | 0.748 (+/- 0.020) |
| Component Alignment (side/side) | Pd | 0.040 (max) |
| Component Alignment (front/back) | Hd | 0.031 (max) |
| Component Pitch | P | 0.500 (+/- 0.020) |
| Feed Hole Pitch | PO | 0.500 (+/- 0.008) |
| Hole Center to First Lead | P1 | 0.150 (+0.009, -0.010) |
| Hole Center to Component Center | P2 | 0.247 (+/- 0.007) |
| Lead Spread | F1/F2 | 0.104 (+/- 0 .010) |
| Lead Thickness | d | 0.018 (+0.002, -0.003) |
| Cut Lead Length | L | 0.429 (max) |
| Taped Lead Length | L1 | 0.209 (+0.051, -0.052) |
| Taped Lead Thickness | t | 0.032 (+/- 0.006) |
| Carrier Tape Thickness | t1 | 0.021 (+/- 0.006) |
| Carrier Tape Width | W | 0.708 (+0.020, -0.019) |
| Hold - down Tape Width | WO | 0.236 (+/- 0.012) |
| Hold - down Tape position | W1 | 0.035 (max) |
| Feed Hole Position | W2 | 0.360 (+/- 0.025) |
| Sprocket Hole Diameter | DO | 0.157 (+0.008, -0.007) |
| Lead Spring Out | S | 0.004 (max) |
| | | |

Note: All dimensions are in inches.

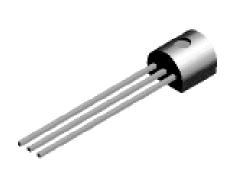
| ITEM DESCRIPTION | SYSMBOL | MINIMUM | MAXIMUM |
|--------------------------------|---------|---------|---------|
| Reel Diameter | D1 | 13.975 | 14.025 |
| Arbor Hole Diameter (Standard) | D2 | 1.160 | 1.200 |
| (Small Hole) | D2 | 0.650 | 0.700 |
| Core Diameter | D3 | 3.100 | 3.300 |
| Hub Recess Inner Diameter | D4 | 2.700 | 3.100 |
| Hub Recess Depth | W1 | 0.370 | 0.570 |
| Flange to Flange Inner Width | W2 | 1.630 | 1.690 |
| Hub to Hub Center Width | W3 | | 2.090 |
| | | | |

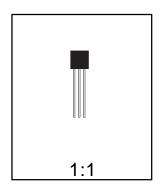
Note: All dimensions are inches

TO-92 Package Dimensions



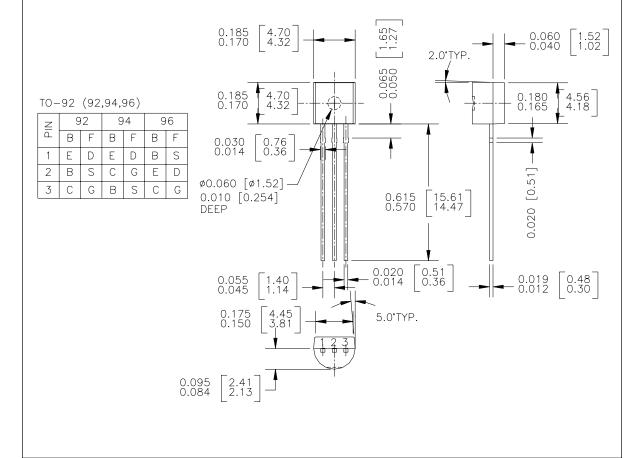
TO-92 (FS PKG Code 92, 94, 96)





Scale 1:1 on letter size paper
Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.1977



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